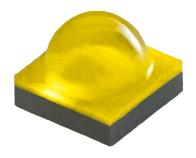
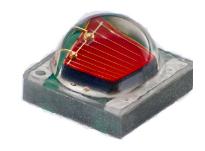


Cree[®] XLamp[®] XB-D LEDs







PRODUCT DESCRIPTION

The XLamp® XB-D LED brings nextgeneration performance, price and size to all LED lighting applications. The XB-D's footprint enables smaller designs with densely packed arrays for better light mixing and concentration.

The XB-D shares common footprint and uniform package design across all white and color configurations, simplifying board and optical designs for many LED systems. The XB-D is optimized to dramatically lower system cost in any illumination application, from indoor and outdoor lighting to architectural and transportation lighting.

FEATURES

- Cree's smallest lighting class
 LED: 2.45 X 2.45 mm
- XB-D white binned @ 85 °C;
 XB-D color binned @ 25 °C
- Up to 136 lm/W in cool white (@ 85 °C, 350 mA)
- Available in white, 80-minimum CRI white, and 70-minimum CRI cool white, royal blue, blue, green, amber, red-orange & red
- 1 A maximum drive current
- Wide viewing angle: from 115° (white) to 140° (red)
- Reflow solderable JEDEC
 J-STD-020C compatible
- Unlimited floor life at
 ≤ 30 °C/85% RH
- Electrically neutral thermal path
- RoHS- and REACh-compliant
- UL-recognized component (E349212)



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CHARACTERISTICS

Characteristics	Unit	Minimum	Typical	Maximum
Thermal resistance, junction to solder point - white, royal blue, blue	°C/W		6.5	
Thermal resistance, junction to solder point - green	°C/W		11	
Thermal resistance, junction to solder point - amber	°C/W		7	
Thermal resistance, junction to solder point - red-orange, red	°C/W		5	
Viewing angle (FWHM) - white	degrees		115	
Viewing angle (FWHM) - royal blue, blue, green	degrees		135	
Viewing angle (FWHM) - amber, red-orange, red	degrees		140	
Temperature coefficient of voltage - white	mV/°C		-2.5	
Temperature coefficient of voltage - royal blue, blue, green	mV/°C		-3.3	
Temperature coefficient of voltage - amber, red-orange, red	mV/°C		-2	
ESD withstand voltage (HBM per Mil-Std-883D) - white, royal blue, blue, green	V			8000
ESD classification (HBM per Mil-Std-883D) - amber, red-orange, red			Class 2	
DC forward current	mA			1000
Reverse voltage	V			-5
Forward voltage (@ 350 mA, 85 °C) - white	V		2.9	3.5
Forward voltage (@ 350 mA, 25 °C) - royal blue, blue	V		3.1	3.7
Forward voltage (@ 350 mA, 25 °C) - green	V		3.3	3.9
Forward voltage (@ 350 mA, 25 °C) - amber, red-orange, red	V		2.25	2.6
LED junction temperature	°C			150



FLUX CHARACTERISTICS - WHITE $(T_1 = 85 \text{ °C})$

The following table provides several base order codes for XLamp XB-D LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XB-D LED Binning and Labeling document.

Color	ссті	Range		se Order Coo . Luminous I @ 350 mA			d Minimum Flux (lm)**	Order Code
	Min.	Max.	Group	Flux (lm) @ 85 °C	Flux (lm) @ 25 °C*	700 mA	1000 mA	
Cool White	5000 K	8300 K	R3	122	139	210	271	XBDAWT-00-0000-000000F51
Cool White	5000 K	8300 K	R2	114	130	196	253	XBDAWT-00-0000-000000E51
70 CRI Minimum	5000 K	8300 K	R3	122	139	210	271	XBDAWT-00-0000-00000BF51
Cool White	3000 K	6300 K	R2	114	130	196	253	XBDAWT-00-0000-00000BE51
			R2	114	130	196	253	XBDAWT-00-0000-00000LEE4
Neutral White	3700 K	5000 K	Q5	107	122	184	237	XBDAWT-00-0000-00000LDE4
			Q4	100	114	172	222	XBDAWT-00-0000-00000LCE4
			Q4	100	114	172	222	XBDAWT-00-0000-00000HCE7
80 CRI Minimum White	2600 K	6200 K	Q3	93.9	107	162	208	XBDAWT-00-0000-00000HBE7
			Q2	87.4	100	150	194	XBDAWT-00-0000-00000HAE7
			Q4	100	114	172	222	XBDAWT-00-0000-00000LCE7
Warm White	2600 K	00 K 3700 K	Q3	93.9	107	162	208	XBDAWT-00-0000-00000LBE7
			Q2	87.4	100	150	194	XBDAWT-00-0000-00000LAE7

Notes:

- Cree maintains a tolerance of $\pm 7\%$ on flux and power measurements, ± 0.005 on chromaticity (CCx, CCy) measurements and ± 2 on CRI measurements. See the Measurements section (page 14).
- Typical CRI for Neutral White, 3700 K 5000K CCT is 75.
- Typical CRI for Warm White, 2600 K 3700 K CCT is 80.
- Minimum CRI for 70 CRI Minimum Cool White is 70.
- Minimum CRI for 80 CRI Minimum White is 80.
- * Flux values @ 25 °C are calculated and are for reference only.
- ** Calculated flux values at 700 mA and 1000 mA are for 85 °C and are for reference only.



FLUX CHARACTERISTICS - COLOR (T₁ = 25 °C)

The following tables provide several base order codes for XLamp XB-D LEDs. It is important to note that the base order codes listed here are a subset of the total available order codes for the product family. For more order codes, as well as a complete description of the order-code nomenclature, please consult the XLamp XB-D LED Binning and Labeling document.

	Dominant Wavelength Range Base Order Codes Min. Radiant Flux		Dominant Wavelength Range							
Color	Min.		Max.		(mW) @ 350 mA		Order Code			
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (mW)				
					465	33 (M) 5		34 (N)	550	XBDROY-00-0000-000000N01
				465				33 (M)	525	XBDROY-00-0000-000000M01
Royal Blue	D36	450	D57				500	XBDROY-00-0000-000000L01		
				31 (K)	475	XBDROY-00-0000-000000K01				
					30 (J)	450	XBDROY-00-0000-000000J01			

	Domi	nant Wav	elength F	Range		rder Codes			
Color	Min.		Max.		(lm) @ 350 mA		Min. Luminous Flux (lm) @ 350 mA		Order Code
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)			
				B6 485	M2	39.8	XBDBLU-00-0000-000000201		
Blue	В3	465	В6		К3	35.2	XBDBLU-00-0000-000000Z01		
					K2	30.6	XBDBLU-00-0000-000000Y01		

	Domi	nant Wav	elength F	Range		rder Codes								
Color	Min.		Max.		Min. Luminous Flux (Im) @ 350 mA		Order Code							
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)								
					Q5	107	XBDGRN-00-0000-00000D01							
Green	G2	520	G4	G4	G4	G4	G4	C4	G4 535	E2E	525	Q4	100	XBDGRN-00-0000-000000C01
Green	G2	520					535	1 333		Q3	93.9	XBDGRN-00-0000-000000B01		
					Q2	87.4	XBDGRN-00-0000-000000A01							

	Dominant Wavelength Range					rder Codes										
Color	Min.		Max.		Min. Luminous Flux (Im) @ 350 mA		Order Code									
	Group	DWL (nm)	Group	DWL (nm)	Group	Flux (lm)										
														Р3	73.9	XBDAMB-00-0000-000000801
Amber	A2	585	А3	А3	۸.2	A3 595 P2 N4	FOF	FOF	2 505	505	P2	67.2	XBDAMB-00-0000-000000701			
Allibei	AZ	363			595		N4	62	XBDAMB-00-0000-000000601							
				N3	56.8	XBDAMB-00-0000-000000501										



FLUX CHARACTERISTICS - COLOR ($T_1 = 25$ °C) - CONTINUED

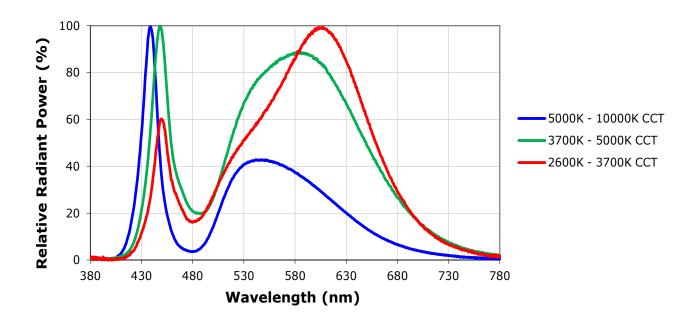
	Dominant Wavelength Range					rder Codes		
Color	Min.		Max.		Min. Luminous Flux (Im) @ 350 mA		Order Code	
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (lm)			
				O4 620		Q4	100	XBDRDO-00-0000-000000C01
						Q3	93.9	XBDRDO-00-0000-000000B01
Red- Orange	О3	610	04		Q2	87.4	XBDRDO-00-0000-000000A01	
				P4	80.6	XBDRDO-00-0000-00000901		
					Р3	73.9	XBDRDO-00-0000-00000801	

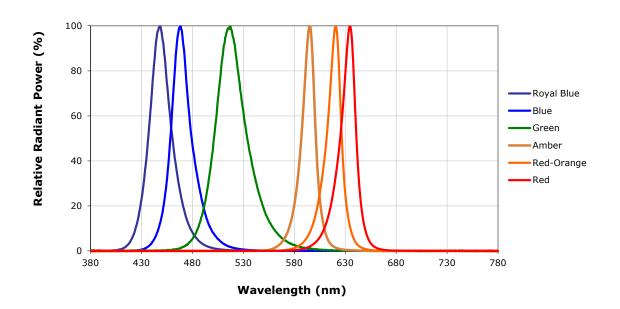
	Domi	nant Wav	elength F	Range		rder Codes						
Color	Min.		Max.		Min. Luminous Flux (lm) @ 350 mA		Order Code					
	Group	DWL (nm)	Group	DWL (nm)	Group Flux (lm)							
										P2	67.2	XBDRED-00-0000-000000701
Red	R2	620	R3	630	N4	62	XBDRED-00-0000-00000601					
					N3	56.8	XBDRED-00-0000-00000501					

Note: Cree maintains a tolerance of \pm 7% on flux and power measurements and \pm 1 nm on dominant wavelength measurements. See the Measurements section (page 14).



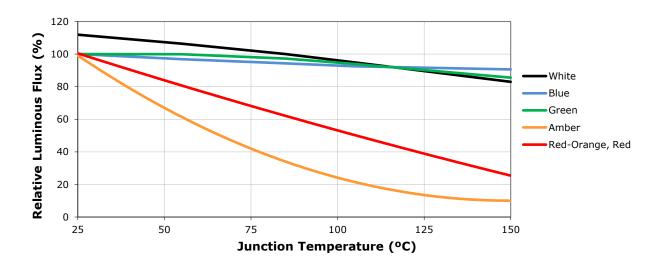
RELATIVE SPECTRAL POWER DISTRIBUTION

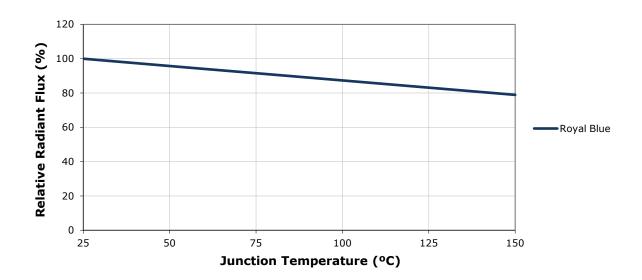






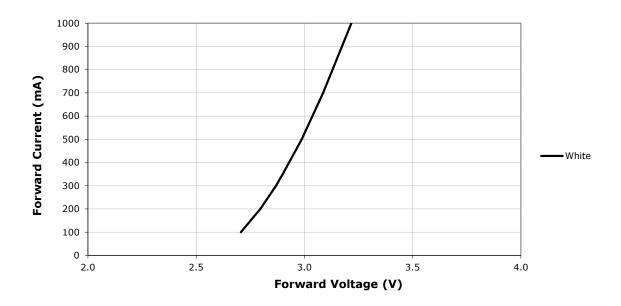
RELATIVE FLUX VS. JUNCTION TEMPERATURE ($I_F = 350 \text{ mA}$)



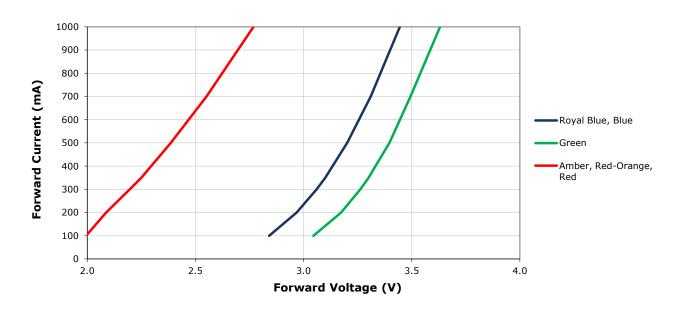




ELECTRICAL CHARACTERISTICS (T_j = 85 °C)

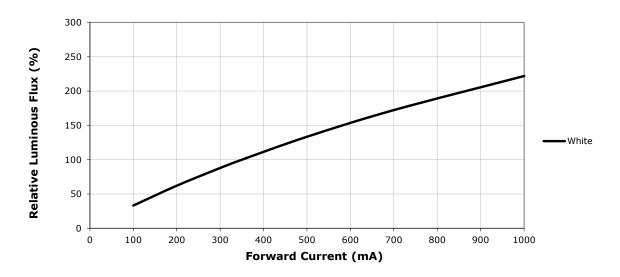


ELECTRICAL CHARACTERISTICS (T₁ = 25 °C)

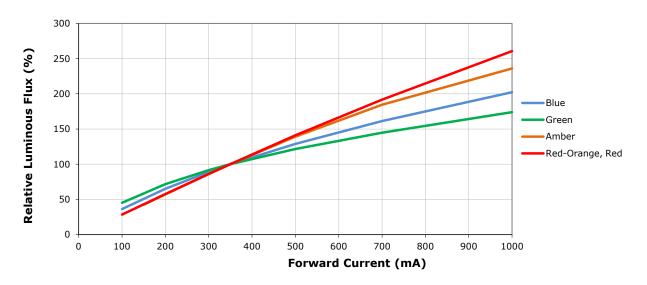




RELATIVE FLUX VS. CURRENT ($T_1 = 85$ °C)

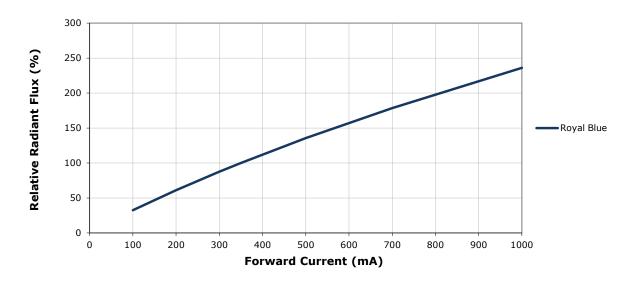


RELATIVE FLUX VS. CURRENT ($T_1 = 25$ °C)

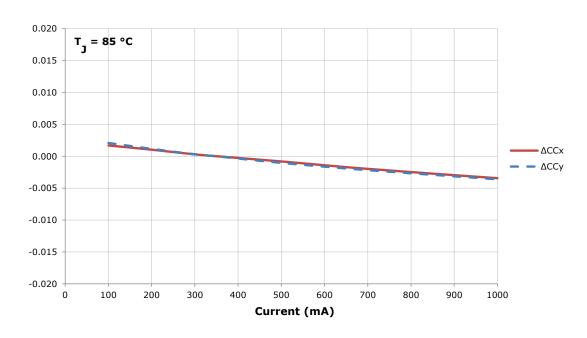




RELATIVE FLUX VS. CURRENT ($T_{j} = 25 \, ^{\circ}\text{C}$) - CONTINUED

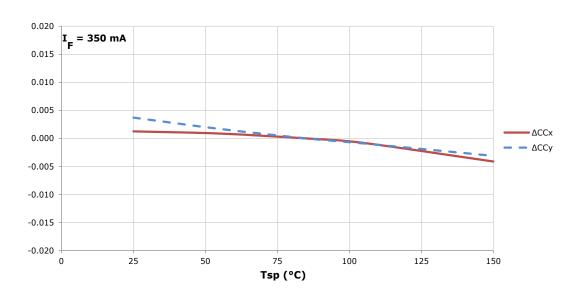


RELATIVE CHROMATICITY VS. CURRENT (WARM WHITE)

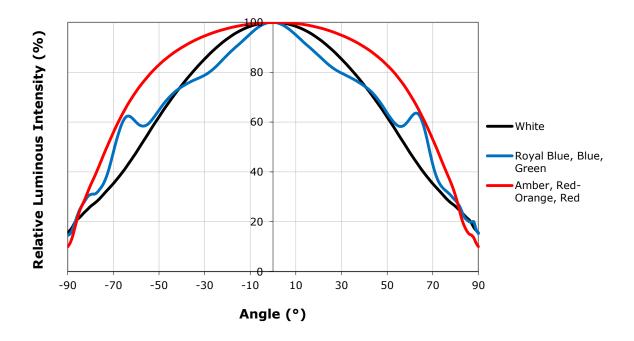




RELATIVE CHROMATICITY VS. TEMPERATURE (WARM WHITE)



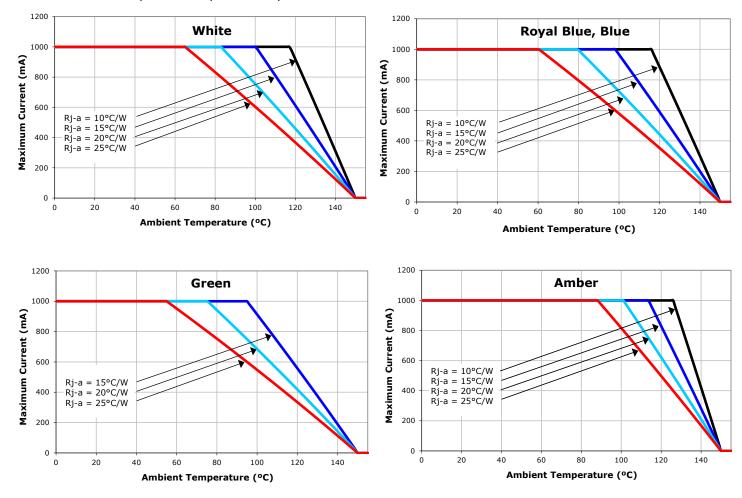
TYPICAL SPATIAL DISTRIBUTION

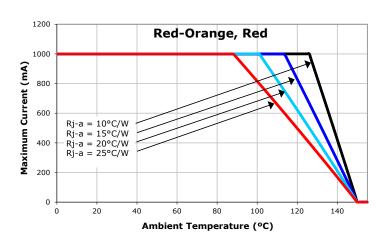




THERMAL DESIGN

The maximum forward current is determined by the thermal resistance between the LED junction and ambient. It is crucial for the end product to be designed in a manner that minimizes the thermal resistance from the solder point to ambient in order to optimize lamp life and optical characteristics.



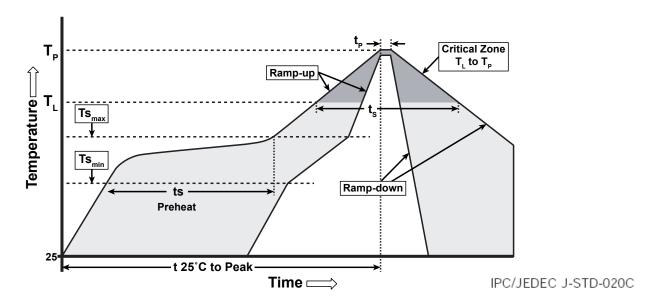




REFLOW SOLDERING CHARACTERISTICS

In testing, Cree has found XLamp XB-D LEDs to be compatible with JEDEC J-STD-020C, using the parameters listed below. As a general guideline, Cree recommends that users follow the recommended soldering profile provided by the manufacturer of solder paste used.

Note that this general guideline may not apply to all PCB designs and configurations of reflow soldering equipment.



Profile Feature	Lead-Based Solder	Lead-Free Solder
Average Ramp-Up Rate (Ts _{max} to Tp)	3 °C/second max.	3 °C/second max.
Preheat: Temperature Min (Ts _{min})	100 °C	150 °C
Preheat: Temperature Max (Ts _{max})	150 °C	200 °C
Preheat: Time (ts _{min} to ts _{max})	60-120 seconds	60-180 seconds
Time Maintained Above: Temperature (T_L)	183 °C	217 °C
Time Maintained Above: Time (t _L)	60-150 seconds	60-150 seconds
Peak/Classification Temperature (Tp)	215 °C	260 °C
Time Within 5 °C of Actual Peak Temperature (tp)	10-30 seconds	20-40 seconds
Ramp-Down Rate	6 °C/second max.	6 °C/second max.
Time 25 °C to Peak Temperature	6 minutes max.	8 minutes max.

Note: All temperatures refer to topside of the package, measured on the package body surface.



NOTES

Measurements

The luminous flux, radiant power, chromaticity and CRI measurements in this document are binning specifications only and solely represent product measurements as of the date of shipment. These measurements will change over time based on a number of factors that are not within Cree's control and are not intended or provided as operational specifications for the products. Calculated values are provided for informational purposes only and are not intended as specifications.

Lumen Maintenance

Cree now uses standardized IES LM-80-08 and TM-21-11 methods for collecting long-term data and extrapolating LED lumen maintenance. For information on the specific LM-80 data sets available for this LED, refer to the public LM-80 results document.

Please read the Long-Term Lumen Maintenance application note for more details on Cree's lumen maintenance testing and forecasting. Please read the Thermal Management application note for details on how thermal design, ambient temperature, and drive current affect the LED junction temperature.

Moisture Sensitivity

Cree recommends keeping XLamp LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain XLamp LEDs do not need special storage for moisture sensitivity.

Once the MBP is opened, XLamp XB-D LEDs may be stored as MSL 1 per JEDEC J-STD-033, meaning they have unlimited floor life in conditions of ≤ 30 °C/85% relative humidity (RH). Regardless of storage condition, Cree recommends sealing any unsoldered LEDs in the original MBP.

RoHS Compliance

The levels of RoHS restricted materials in this product are below the maximum concentration values (also referred to as the threshold limits) permitted for such substances, or are used in an exempted application, in accordance with EU Directive 2011/65/EC (RoHS2), as implemented January 2, 2013. RoHS Declarations for this product can be obtained from your Cree representative or from the Product Documentation sections of www.cree.com.

REACh Compliance

REACh substances of high concern (SVHCs) information is available for this product. Since the European Chemical Agency (ECHA) has published notice of their intent to frequently revise the SVHC listing for the foreseeable future, please contact a Cree representative to insure you get the most up-to-date REACh SVHC Declaration. REACh banned substance information (REACh Article 67) is also available upon request.

UL Recognized Component

Level 4 enclosure consideration. The LED package or a portion thereof has been investigated as a fire and electrical enclosure per ANSI/UL 8750.



NOTES

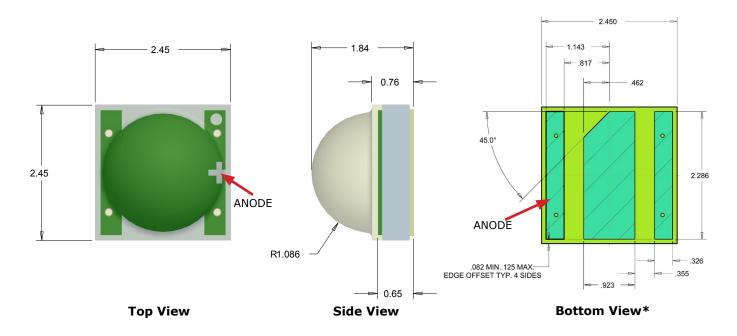
Vision Advisory

WARNING: Do not look at exposed lamp in operation. Eye injury can result. For more information about LEDs and eye safety, please refer to the LED Eye Safety application note.

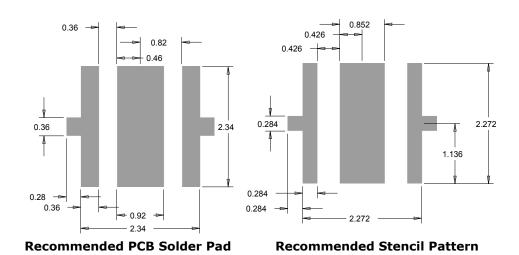


MECHANICAL DIMENSIONS

All measurements are $\pm .13$ mm unless otherwise indicated.



* Note: In December, 2012, Cree changed the thermal pad of the XB-D package to include the anode notch illustrated above. XB-D LEDs produced prior to implementation of this change may have a different visual appearance.



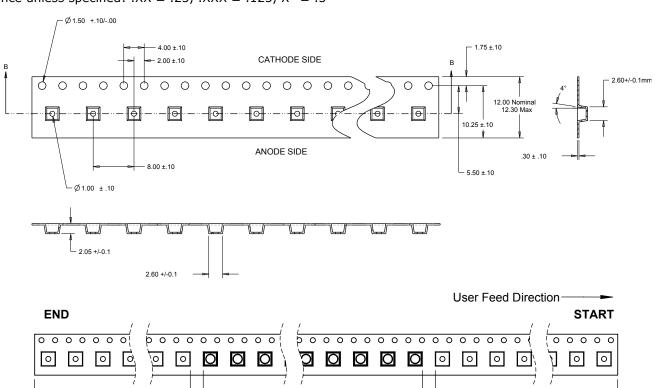


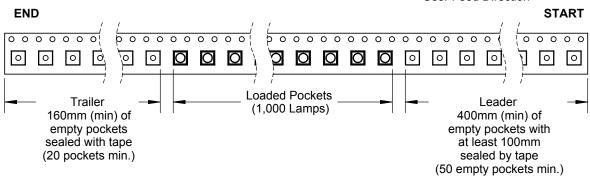
TAPE AND REEL

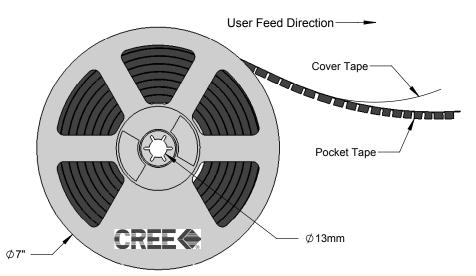
All Cree carrier tapes conform to EIA-481D, Automated Component Handling Systems Standard.

All dimensions in mm

Tolerance unless specified: .XX \pm .25, .XXX \pm .125, X° \pm .5°









PACKAGING

Unpackaged Reel

Label with Cree Bin Code, Qty, Reel ID

Packaged Reel

